Amendments to the Claims

substrate.

- 1. (Currently Amended) An electric device comprising:
- a substrate (2,42,50) having a main surface of a first material, and
- a nanostructure (1,44,51) of a second material, wherein the first and second materials having a mutual lattice mismatch, and wherein the nanostructure being supported by and being in epitaxial relationship with the
- 2. (Currently Amended) A device according to claim 1, wherein the nanostructure (1,44,51)-is in electrical contact with the substrate (2,42,50).
- 3. (Currently Amended) A device according to claim 2, wherein the resistance between the nanostructure (1,44,51) and the substrate (2,42,50) is below 10^{-5} Ohm cm².
- 4. (Currently Amended) A device according to claim 1, wherein the nanostructure (1,44,51) is a nanotube and/or the nanostructure is a nanowire.
- 5. (Currently Amended) A device according to claim 1, wherein a lattice mismatch between the substrate (2,42,50) and the nanostructure(s) (1,44,51) is smaller than 10%.
- 6. (Currently Amended) A device according to claim 1, wherein the nanostructure (1,44,51)-is a substantially single-crystal nanostructure.
- 7. (Original) A device according to claim 1, wherein a plurality of nanostructures are arranged in an array.
- 8. (Original) A device according to claim 1, wherein the electric device is a gate-around transistor.

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- 9. (Currently Amended) A device according to claim 8, further comprising a first dielectric (45,53) and wherein the first dielectric is in contact with at least a section of the nanostructure(s) (1,44,51).
- 10. (Currently Amended) A device according to claim 9, further comprising a first conductive material (46,55,65) and wherein the first conductive material is electrically insulated from the substrate by the first dielectric (45,53).
- 11. (Currently Amended) A device according to claim 10, further comprising a second dielectric (54) and wherein the second dielectric is electrically insulating the first conductive material (46,55,65) from the nanostructure (1,44,51).
- 12. (Original) A device according to claim 11 wherein the first dielectric is thicker than the second dielectric.
- 13. (Currently Amended) A device according to claim 1, further comprising a second conductive material (48,59) and wherein the second conductive material is in contact with at least one nanostructure (1,44,51).
- 14. (Currently Amended) A device according to claim 13, further comprising at least a third dielectric (47,56,57), the at least third dielectric insulating the second conductive material (48,59) from the first conductive material (46,55,65).
- 15. (Currently Amended) A method of growing a second material in epitaxial relationship with a first material, the second material and the first material having a mutual lattice mismatch, the method comprising the steps of:
- providing a substrate (2,42,50) of the first material,
- forming a nanostructure (1,44,51) of the second material by a growth method,

wherein the first material comprising at least one element from a first group in the periodic table and the second material comprising at least one element from a second group, the second group being different from the first group, and wherein the nanostructure being supported by and in epitaxial relationship with the substrate.

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16. (Currently Amended) A method according to claim 15, wherein the nanostructure is grown according to the vapour-liquid-solid (VLS) growth method.